

BT151X-650LTN

Rev.03 - 22 December 2022

Product data sheet

1. General description

Planar passivated Silicon Controlled Rectifier (SCR) in a TO220F "full pack" plastic package intended for use in applications requiring good bidirectional blocking voltage and high current surge capability with high thermal cycling performance and high junction temperature capability ($T_{i(max)} = 150$ °C).

2. Features and benefits

- High junction operating temperature capability (T_{i(max)} = 150 °C)
- · Good bidirectional blocking voltage capability
- High current surge capability
- High thermal cycling performance
- Isolated mounting base package
- Planar passivated for voltage ruggedness and reliability

3. Applications

- Capacitive Discharge Ignition (CDI)
- Crowbar protection
- Inrush protection
- Motor control
- Voltage regulation
- High junction operating temperature capability (T_{j(max)} = 150 °C)

4. Quick reference data

	k reference data		Mat a	11.14
Symbol	Parameter	Conditions	Values	Unit
Absolute ma	aximum rating			
V_{RRM}	repetitive peak reverse voltage		650	V
$I_{T(RMS)}$	RMS on-state current	half sine wave; T _h ≤ 95 °C; <u>Fig. 1; Fig. 2; Fig. 3</u>	12	A
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; t_p = 10 ms; Fig. 4; Fig. 5	120	A
		half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms	132	А
T _j	junction temperature		150	°C

SCR

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static cha	Static characteristics						
I _{GT}	gate trigger current	V_{D} = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 7</u>		1.5	-	5	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>		-	-	20	mA
V _T	on-state voltage	I _T = 12 A; T _j = 25 °C; <u>Fig. 10</u>		-	1.15	1.5	V
Dynamic characteristics							
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 436 V; T _j = 150 °C; R _{GK} = 100 Ω ; (V _{DM} = 67% of V _{DRM}); exponential waveform;		500	1000	-	V/µs

5. Pinning information

Pin	Pinning infor Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	mb	
2	A	anode		А-Ң К
3	G	gate		G sym037
mb	n.c.	mounting base; isolated		

6. Ordering information

Table 3. Ordering information								
Type number	Package	Orderable part number	Packing	Small packing	Package	Package		
	name		method	quantity	version	issue date		
BT151X-650LTN	TO220F	BT151X-650LTNQ	Tube	50	SOT186A	14-Nov-2013		

7. Marking

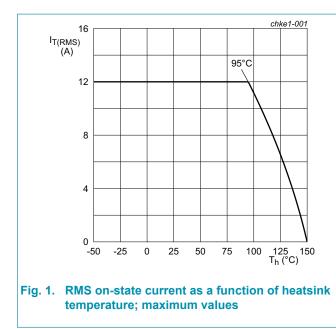
Table 4. Marking codes			
Type number	Marking codes		
	Assembly factory: d	Assembly factory: A	
BT151X-650LTN	BT151X 650LTN PJdxxxx xx	BT151X 650LTN PJAxxxx xx	

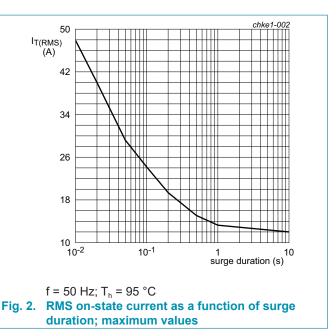
8. Limiting values

Table 5. Limiting values

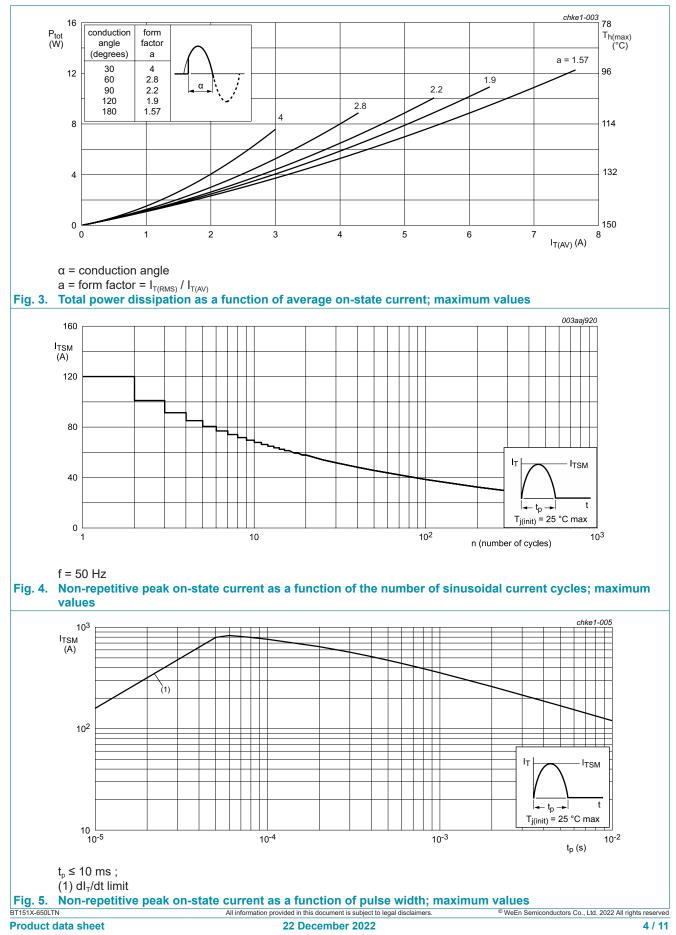
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V _{drm}	repetitive peak off-state voltage		650	V
V _{RRM}	repetitive peak reverse voltage		650	V
I _{T(AV)}	average on-state current	half sine wave; $T_h \le 95 \degree C$	7.5	А
I _{T(RMS)}	RMS on-state current	half sine wave; T _h ≤ 95 °C; <u>Fig. 1; Fig. 2; Fig. 3</u>	12	A
I _{TSM}	non-repetitive peak on- state current	half sine wave; T _{j(init)} = 25 °C; t _p = 10 ms; <u>Fig. 4; Fig. 5</u>	120	A
		half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms	132	A
l ² t	l ² t for fusing	t _p = 10ms; sine wave	72	A²s
dl _⊤ /dt	rate of rise of on-state current	I _G = 10mA	50	A/µs
I _{GM}	peak gate current		2	А
V _{RGM}	peak reverse gate voltage		18	V
P _{GM}	peak gate power		5	W
P _{G(AV)}	average gate power	over any 20 ms period	0.5	W
T _{stg}	storage temperature		-40 to 150	°C
Tj	junction temperature		150	°C



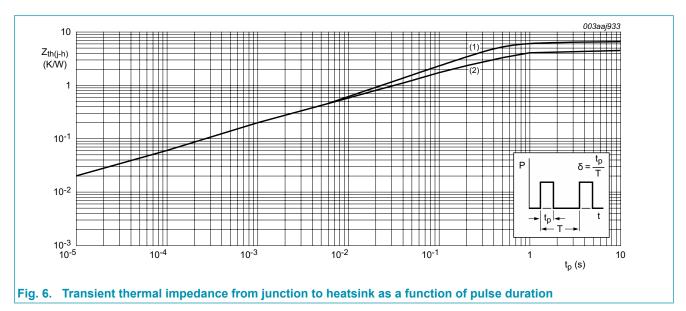


BT151X-650LTN SCR



9. Thermal characteristics

Table 6. Th	ermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
R _{th(j-h)} thermal resistance from junction to heatsink	with heatsink compound; Fig. 6	-	-	4.5	K/W	
	2	without heatsink compound; Fig. 6	-	-	6.5	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	55	-	K/W

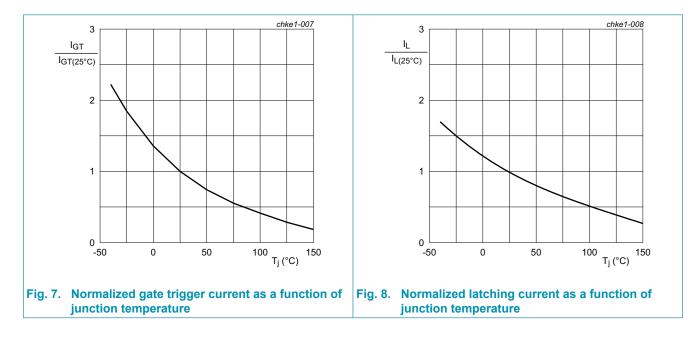


10. Isolation characteristics

Table 7. Isolation characteristics							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{isol(RMS)}$	RMS isolation voltage	50 Hz \leq f \leq 60 Hz; RH \leq 65 %; from all pins to external heatsink; sinusoidal waveform; clean and dust free		-	-	2500	V
C _{isol}	isolation capacitance	from cathode to external heatsink		-	10	-	pF

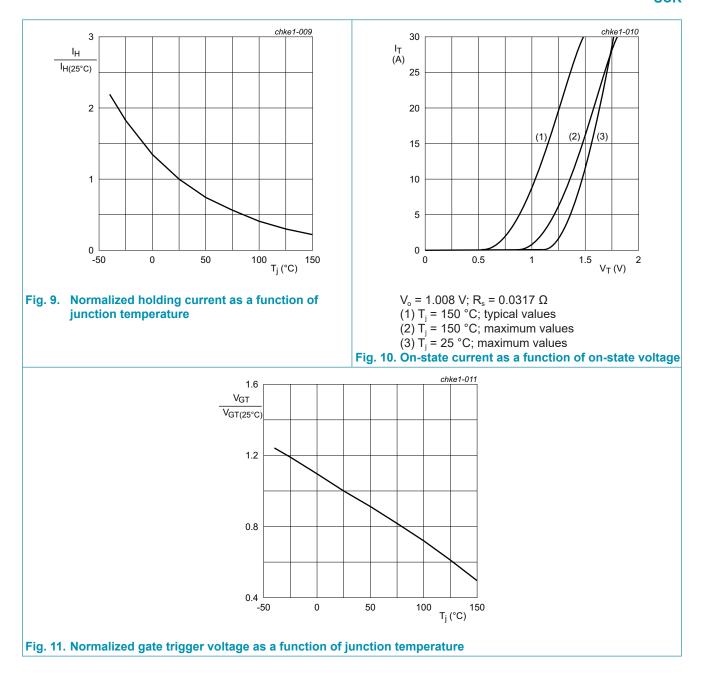
11. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics	· · · · · · · · · · · · · · · · · · ·				
I _{GT}	gate trigger current	V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 7</u>	1.5	-	5	mA
I _L	latching current	V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 8</u>	-	-	40	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	-	20	mA
V _T	on-state voltage	I _T = 12 A; T _j = 25 °C; <u>Fig. 10</u>	-	1.15	1.5	V
V _{gt}	gate trigger voltage	$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; T_{j} = 25 \text{ °C};$ Fig. 11	-	0.65	1	V
		V _D = 400 V; I _T = 0.1 A; T _j = 150 °C	0.2	0.4	-	V
I _D	off-state current	V _D = 650 V; T _j = 150 °C	-	-	1	mA
I _R	reverse current	V _D = 650 V; T _j = 150 °C	-	-	1	mA
Dynamic o	haracteristics	· · · · · · · · · · · · · · · · · · ·				_
dV _D /dt rate of rise of off-state voltage		V_{DM} = 436 V; T _j = 150 °C; R _{GK} = 100 Ω ; (V _{DM} = 67% of V _{DRM}); exponential waveform;	500	1000	-	V/µs
		V_{DM} = 436 V; T _j = 150 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	50	-	-	V/µs
t _{gt}	gate-controlled turn-on time	$I_{TM} = 12 \text{ A}; V_D = 650 \text{ V}; I_G = 100 \text{ mA};$ $(dI_G/dt)_M = 5 \text{ A}/\mu\text{s}; T_j = 25 \text{ °C}$		2	-	μs
t _q	commutated turn-off time			70	-	μs



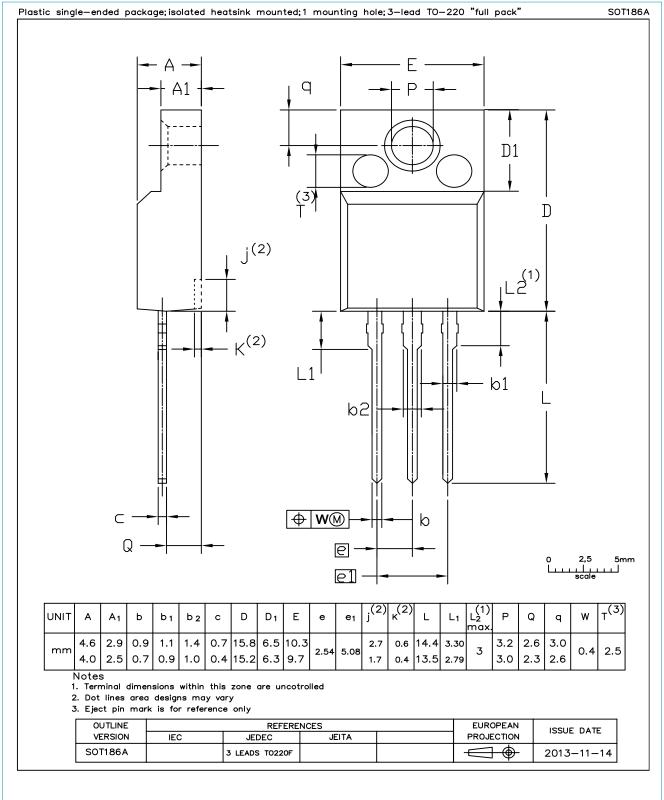
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BT151X-650LTN



12. Package outline

Assembly factory: d & A



13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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